

3DD505, BU104**NPN Silicon Low Frequency High Power Transistor****Features:**

1. Heavy working current. Good temperature stability. Excellent thermal fatigue capability.
2. Implementation of standards: GJB33 A-97, QZJ840611A, QZJ840611
3. Use for Low-speed switch, low frequency power amplify, power adjustment.
4. Quality Class: JP, JT, JCT, GS, G, G+

TECHNICAL DATA:**(Ta = 25°C)**

Parameter name	Symbols	Unit	Specifications	Parameter name	Symbols	Specifications
			3DD505			BU104
Collector-Emitter Voltage	V _{CEO}	V	400			150
Emitter-Base Voltage	V _{EBO}	V	6			10
Max. Collector Current	I _{CM}	A	5			7
Max. Collector Dissipation	P _{CM}	W	75(T _c =25°C)			85(T _c =25°C)
Junction Temperature	T _{jm}	°C	175			175
Storage Temperature	T _{stg}	°C	-55~+175			-55~+175
Emitter-Base Leakage Current	I _{EBO}	mA	-			Max.:10
			-			V _{EB} =10V
Collector-Emitter Leakage Current	I _{CEO}	mA	Max.:3.0	Collector-Base Leakage Current	I _{CBO}	Max.:0.5
			V _{CE} =100V			V _{CB} =100V
C-Base Breakdown Voltage	V _{(BR)CBO}	V	-	-		≥400(I _c =5Ma)
Collector- Emitter Saturation Voltage Drop	V _{CE(sat)}	V	Max.:1.2			Max.:1.5
			I _c =1.5A, I _B =0.05A			I _c =7A, I _B =1A
DC Current Gain	h _{FE}		Min.:40, Max.:120			Min.:15
			V _{CE} = 2V, I _c =5A			V _{CE} = 4V, I _c =7A
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	V	≥400			≥150
			I _c =1mA			I _c =5mA
E-Base Breakdown Voltage	V _{(BR)EBO}	V	≥6			≥10
			I _E =1mA			I _E =0.5mA

Outline and Dimensions: